

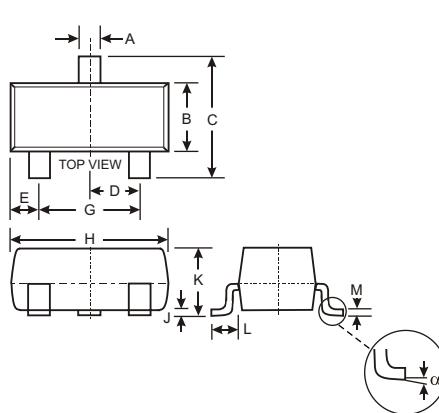


Features

- Silicon planar epitaxial high speed diode
- For switching and general purpose applications

Mechanical Data

- Case:SOT-23
- Weight: 0.008 grams (approximate)



SOT-23		
Dim	Min	Max
A	0.37	0.51
B	1.20	1.40
C	2.30	2.50
D	0.89	1.03
E	0.45	0.60
G	1.78	2.05
H	2.80	3.00
J	0.013	0.10
K	0.903	1.10
L	0.45	0.61
M	0.085	0.180
alpha	0°	8°

All Dimensions in mm

Maximum Ratings and Electrical Characteristics $T_A = 25^\circ\text{C}$ unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Parameter	Test Conditions	Type	Symbol	Value	Unit
Working peak reverse voltage =DC Blocking voltage		BAS19	$V_{RWM} = V_R$	100	V
		BAS20	$V_{RWM} = V_R$	150	V
		BAS21	$V_{RWM} = V_R$	200	V
Repetitive peak reverse voltage		BAS19	V_{RRM}	120	V
		BAS20	V_{RRM}	200	V
		BAS21	V_{RRM}	250	V
Peak forward surge current	$t=1\mu\text{s}$		I_{FSM}	2.5	A
	$t=1\text{s}$		I_{FSM}	0.5	A
Repetitive peak forward current			I_{FRM}	625	mA
Average forward current	$t_p < 0.3\text{ms}$		I_{FAV}	200	mA
Forward current	$T_{Case}=T_L$ (8mm from Case) $=T_{amb}$		I_F	400	mA
Power dissipation	$T_{Case}=T_L$ (8mm from Case) $=T_{amb}$		P_{tot}	250	mW
Junction and storage temperature range	$T_J = 25^\circ\text{C}$		$T_J=T_{stg}$	-55...+150	°C

Parameter	Test Conditions	Type	Symbol	Min	Typ	Max	Unit
Forward voltage	$I_F=100\text{mA}$		V_F			1.0	V
	$I_F=200\text{mA}$		V_F			1.25	V
Reverse current	$V_R=V_{Rmax}$		I_R			100	nA
	$V_R=V_{Rmax}, T_J = 150^\circ\text{C}$		I_R			100	μA
Reverse breakdown voltage	$I_R=100\mu\text{A}, t_p < 0.3\text{ms}$	BAS19	$V_{(BR)R}$	120			V
	$I_R=100\mu\text{A}$	BAS20	$V_{(BR)R}$	200			V
	$I_R=100\mu\text{A}, V_R < 275\text{V}$	BAS21	$V_{(BR)R}$	250			V
Reverse recovery time	$I_F=I_R=10\text{mA}, R_L=100\Omega, V_R=6\text{V}$ to $I_R=1\text{mA}, R_L=100\Omega$		t_{rr}			50	ns
Diode capacitance	$V_R=0, f=1\text{MHz}$		C_D			5	pF
Dynamic forward resistance	$I_F=10\text{mA}$		r_f			5	Ω